

# 6<sup>th</sup> Generation CoolSiC<sup>™</sup>

### 650V SiC Schottky Diode

The CoolSiC<sup>TM</sup> Generation 6 is the leading edge technology from Infineon for the SiC Schottky Barrier diodes. The Infineon proprietary diffusion soldering process is combined with a more compact design, thin-wafer technology and a novel Schottky metal system. The result is a family of products with improved efficiency over all load conditions, resulting from a lower figure of merit ( $Q_c \times V_F$ ). CoolSiC<sup>TM</sup> Generation 6 has been designed to complement our 600V and 650V CoolMOS<sup>TM</sup> 7 families, meeting the most stringent application requirements in this voltage range.

Key performance parameters					
Value	Unit				
650	V				
17.1	nC				
3.2	μJ				
12	A				
1.25	V				
	650 17.1 3.2 12				

Table 2	Package information

Type / ordering Code	Package	Marking
IDH12G65C6	PG-TO220-2	D1265C6

### Features

- Best in class forward voltage (1.25 V)
- Best in class figure of merit  $(Q_c \times V_F)$
- High dv/dt ruggedness (150 V/ns)

### **Benefits**

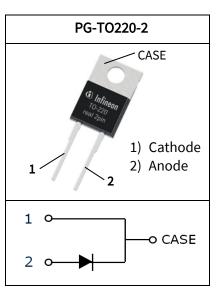
- System efficiency improvement
- System cost and size savings due to the reduced cooling requirements
- Enabling higher frequency and increased power density

### **Potential Applications**

- Power factor correction in SMPS
- Solar inverter
- Uninterruptible power supply

### **Product Validation**

• Qualified for industrial applications according to the relevant tests of JEDEC (J-STD20 and JESD22)







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### Maximum ratings 1

#### Table 3 **Maximum ratings**

Developmenter	Cumhal	Values			11	Nete/Test soudition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note/Test condition
		-	-	12		$T_c \le 140 ^{\circ}\text{C}, D = 1$
Continuous forward current	$I_F$	-	-	15		$T_c \le 125 ^{\circ}\text{C}, D = 1$
		-	-	27		$T_c \le 25 ^{\circ}\text{C}, D = 1$
Surge-repetitive forward current, sine halfwave <sup>1</sup>	I <sub>F,RM</sub>	-	_	53	A	$T_c = 25 ^{\circ}\text{C}, t_p = 10 \text{ms}$
Surge non-repetitive forward	,	-	-	64		$T_c = 25 ^{\circ}\text{C}, t_p = 10 \text{ms}$
current, sine halfwave	I <sub>F,SM</sub>	-	-	51		$T_c = 150 ^{\circ}\text{C}, t_p = 10 \text{ms}$
Non-repetitive peak forward current	I <sub>F,max</sub>	-	-	630		$T_c = 25 \text{ °C}, t_p = 10  \mu\text{s}$
:2+ value	(;2d+	-	-	21	A <sup>2</sup> a	$T_c = 25 ^{\circ}\text{C}, t_p = 10 \text{ms}$
i <sup>2</sup> t value	∫i²dt	-	-	13	– A <sup>2</sup> s	$T_c = 150 ^{\circ}\text{C}, t_p = 10 \text{ms}$
Repetitive peak reverse voltage	V <sub>RRM</sub>	-	-	650	V	<i>T<sub>c</sub></i> = 25 °C
Diode dv/dt ruggedness	dv/dt	-	-	150	V/ns	$V_R = 0480 \text{ V}$
Power dissipation	P <sub>tot</sub>	-	-	81	W	$T_c = 25^{\circ}\text{C}, R_{thJC,max}$
Operating and storage temperature	$\begin{bmatrix} T_j \\ T_{stg} \end{bmatrix}$	-55	-	175	°C	-
Mounting torque	-	_	-	70	Ncm	M3 screw

### **Thermal characteristics** 2

#### Thermal characteristics (PG-TO-220-2) Table 4

Deremeter	Symbol	Values			Unit	Note/Test condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note/Test condition
Thermal resistance, junction- case	$R_{ m thJC}$	-	1.1	1.9		_
Thermal resistance, junction- ambient	<b>R</b> <sub>thJA</sub>	_	-	62	K/W	leaded
Soldering temperature, wavesoldering only allowed at leads	T <sub>sold</sub>	-	-	260	°C	1.6 mm (0.063 in.) from case for 10 s

<sup>&</sup>lt;sup>1</sup> The surge-repetitive forward current test was performed with 1000 pulses (half-wave rectified sine with the 10 ms period). **Final Datasheet** 3



## 3 Electrical characteristics

## 3.1 Static characteristics

### Table 5Static characteristics

Devenenter	C. mark al	Values			Unit	Note/Test soudition
Parameter	Symbol	Min.	Тур.	yp. Max.		Note/Test condition
DC blocking voltage	V <sub>DC</sub>	650	_	_		<i>T<sub>j</sub></i> = 25 °C
Diode forward voltage	V <sub>F</sub>	_	1.25	1.35	V	<i>I<sub>F</sub></i> = 12 A, <i>T<sub>j</sub></i> = 25 °C
		_	1.5	_		<i>I<sub>F</sub></i> = 12 A, <i>T<sub>j</sub></i> = 150 °C
Reverse current	I <sub>R</sub>	_	1.2	40		$V_R$ = 420 V, $T_j$ = 25 °C
		_	40	_	μA	$V_R$ = 420 V, $T_j$ = 125 °C
		-	92	-		$V_R$ = 420 V, $T_j$ = 150 °C

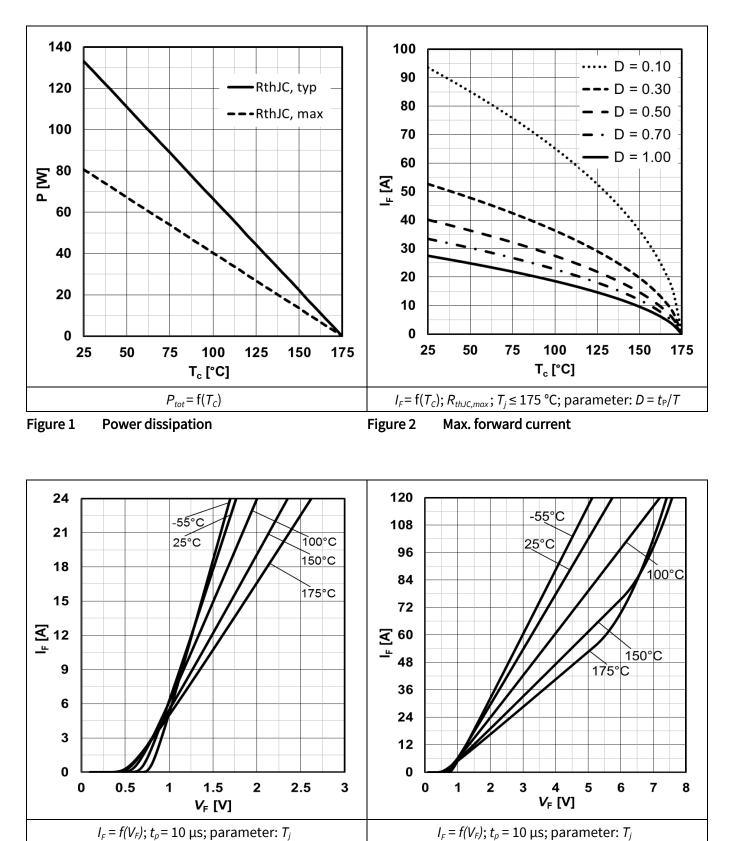
### 3.2 AC characteristics

### Table 6AC characteristics

Daramatar	Cumhal	Values			11	Note /Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note/Test Condition	
Total capacitive charge			17.1			nC	$V_R$ = 400 V, $T_j$ = 150 °C,
	Qc	-	17.1	-		$di/dt = 200 \text{ A}/\mu \text{s}, I_F \leq I_{F,MAX}$	
	tal Capacitance C - 35 - pF		594			$V_R = 1 \text{ V, } f = 1 \text{ MHz,}$	
		-		-		<i>T<sub>j</sub></i> = 25 °C	
Total Capacitanca		~F	$V_R$ = 300 V, $f$ = 1 MHz,				
Total Capacitance		- 35	35	-	рг	<i>T<sub>j</sub></i> = 25 °C	
			24			$V_R$ = 600 V, f = 1 MHz,	
		-	34	34 –		<i>T<sub>j</sub></i> = 25 °C	



## 4 Diagrams





Typ. forward characteristics in surge current

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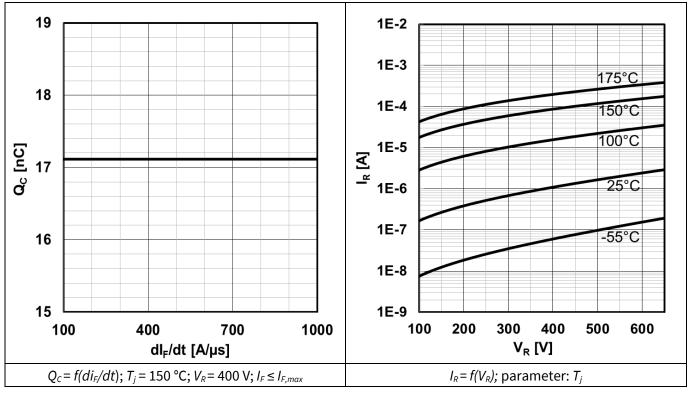
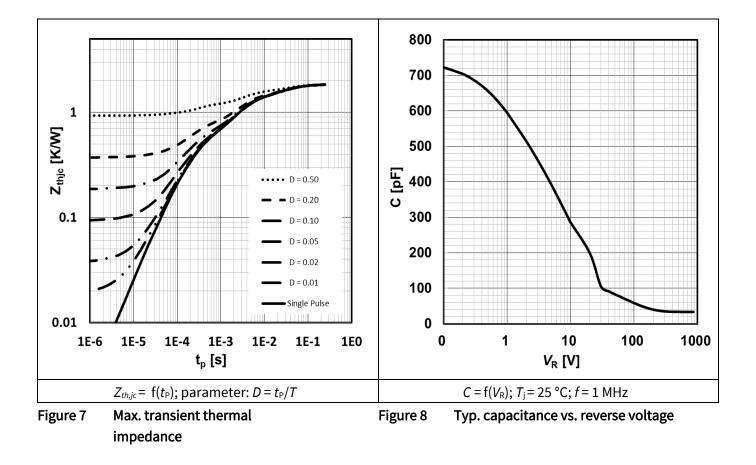


Figure 5 Typ. cap. charge vs. current slope

Figure 6 Typ. reverse current vs. reverse voltage



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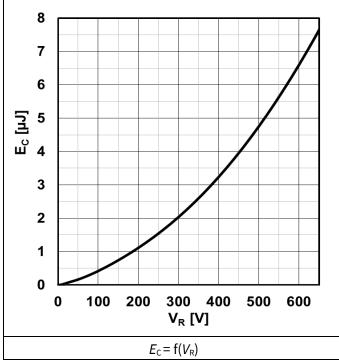
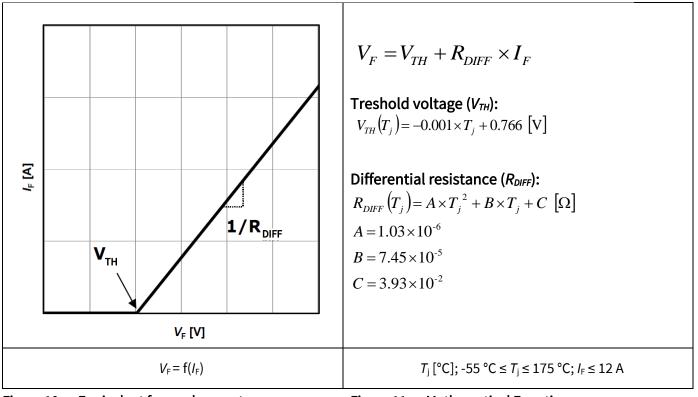


Figure 9 Typ. capacitance stored energy

## 5 Simplified forward characteristic



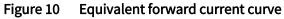


Figure 11 Mathematical Equation



## 6 Package outlines

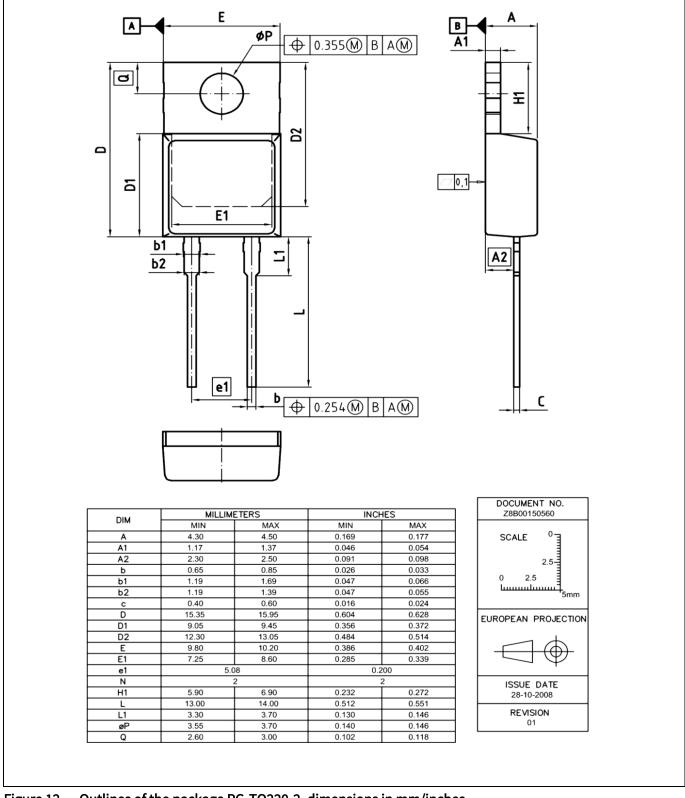


Figure 12 Outlines of the package PG-TO220-2, dimensions in mm/inches



### **Revision History**

### Major changes since the last revision

Revision	Date	Subject (major changes since last revision)					
2.0	2017-05-23	Release of final version					

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Document reference

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